SPECIFICATIONS

CUSTOMER	:	PTC
SAMPLE CODE	:	SH800480T013-IDF02
MASS PRODUCTION CODE	:	PH800480T013-IDF02
SAMPLE VERSION	:	01
SPECIFICATIONS EDITION	:	002
DRAWING NO. (Ver.)	:	JLMD- PH800480T013-IDF02 _001
PACKAGING NO. (Ver.)	:	JLMD- PH800480T013-IDF02 _001

Customer Approved

Date:

POWERTIP
2016.12.30
JS RD APPROVED

Approved	Checked	Designer
閆偉	劉進	陳璐

□ Preliminary specification for design input

■ Specification for sample approval

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History of Version

Date (mm / dd / yyyy)	Ver.	Edi.	Description	Page	Design by
10/13/2016	01	001	New Drawing	-	陳璐
12/14/2016	01	002	New sample	-	陳璐

Total: 32 Page

Contents

1. SPECIFICATIONS

1.1 Features

Item	Standard Value
Display Type	800 * (RGB) * 480
LCD Type	TN (TFT LCD) , Normally white , Transmissive type
Screen size(inch)	7.0 inch
Viewing Direction	6 O'clock
Interface	RGB Interface
ROHS	THIS PRODUCT CONFORMS THE ROHS OF PTC Detail information please refer web site : http://www.powertip.com.tw/news.php?area_id_view=1085560481/

1.2 Mechanical Specifications

Item	Standard Value	Unit
Outline Dimension	192.96(L)*108.76(W)*7.93(H)	mm

LCD panel& Touch Panel

Item	Standard Value	Unit
Active Area	154.08 (W) * 85.92 (L)	mm
Dot pitch	0.1926 (W) * 0.1790 (L)	mm

Note：For detailed information please refer to LCM drawing.

1.3 Absolute Maximum Ratings

Module

Item	Symbol	Condition	Min.	Max.	Unit	Remark
Power Supply Voltage	DV_{DD}	GND=0	-0.3	5.0	V	-
	AV_{DD}		6.5	13.5	V	
	V_{GH}		-0.3	40	V	
	V_{GL}	AGND=0	-20	0.3	V	
	V_{GH} - V_{GL}	-	-	40	V	
Operating Temperature	T_{OP}	-	-20	70	°C	
Storage Temperature	T_{ST}	-	-30	85	°C	

The absolute maximum rating values of this product are not allowed to be exceeded at any times. Should a module be used with any of the absolute maximum ratings exceeded, the characteristics of the module may not be recovered, or in an extreme case, the module may be permanently destroyed.

1.4 DC Electrical Characteristics

Module GND = 0V, Ta = 25°C

Item	Symbol	Min.	Typ.	Max.	Unit	Remark
Supply Voltage	DV_{DD}	3.0	3.3	3.6	V	-
	V_{GH}	15.3	16.0	16.7		
	V_{GL}	-7.7	-7.0	-6.3		
	AV_{DD}	10.2	10.4	10.6		
VCOM	V_{COM}	3.8	4.0	4.2	V	-
Input signal Voltage	V_{IH}	$0.7DV_{DD}$	-	DV_{DD}	V	-
	V_{IL}	0	-	$0.3DV_{DD}$		
Supply Current	I (DV_{DD})	-	4.0	10	mA	DVDD=3.3V
	I (AV_{DD})	-	20	50		AVDD=10.4V
	I_{GH}	-	0.2	1.0		VGH=16.0V
	I_{GL}	-	0.2	1.0		VGL=-7.0V

1.5 Optical Characteristics

TFT LCD Module DV_{DD} = 3.3 V, Ta=25°C

Item		Symbol	Condition	Min.	Typ.	Max.	unit	
Response time	Rise	Tr	-	-	10	20	ms	Note 2
	Fall	Tf		-	15	30		
Viewing angle	Top	θ+	CR ≥ 10	-	80		Deg.	Note 1
	Bottom	θ-		-	80			
	Left	θL		-	80			
	Right	θR		-	80			
Contrast ratio		CR	-	400	500	-		Note 3
Color of CIE Coordinate (With B/L)	White	X	If=270mA	0.27	0.32	0.37	-	Note4
		Y		0.28	0.33	0.38		
	Red	X		0.53	0.58	0.63		
		Y		0.30	0.35	0.40		
	Green	X		0.29	0.34	0.39		
		Y		0.55	0.60	0.65		
	Blue	X		0.10	0.15	0.20		
		Y		0.02	0.07	0.12		
Average Brightness Pattern=white display (With B/L)*1		IV	If=270mA	630	720	-	cd/m^2	Note1
Uniformity (With B/L)*2		△B	-	70	-	-	%	Note1

Note 4 ：

1：△B=B(min) / B(max) * 100%

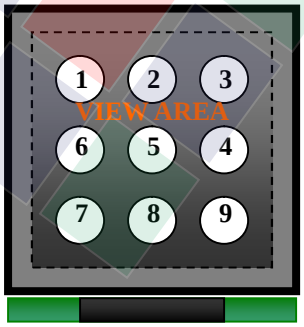
2：Measurement Condition for Optical Characteristics:

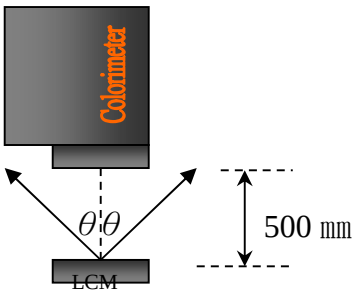
a：Environment: 25℃±5℃ / 60±20%R.H，no wind，dark room below 10 Lux at typical lamp current and typical operating frequency.

b：Measurement Distance: 500 ± 50 ㎜ ，(θ= 0°)

c：Equipment: TOPCON BM-7 fast，(field 1°)，after 10 minutes operation.

d：The uncertainty of the C.I.E coordinate measurement ±0.01，Average Brightness ± 4%



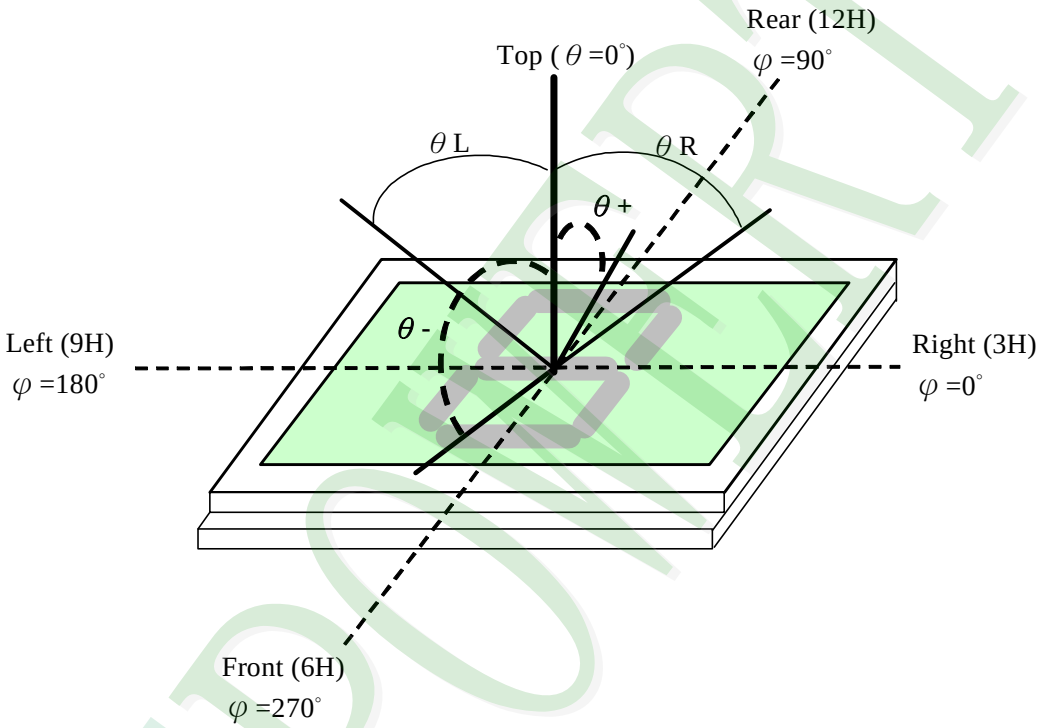


Colorimeter=BM-7 fast

Note 1.

Optical characteristics-2

Viewing angle

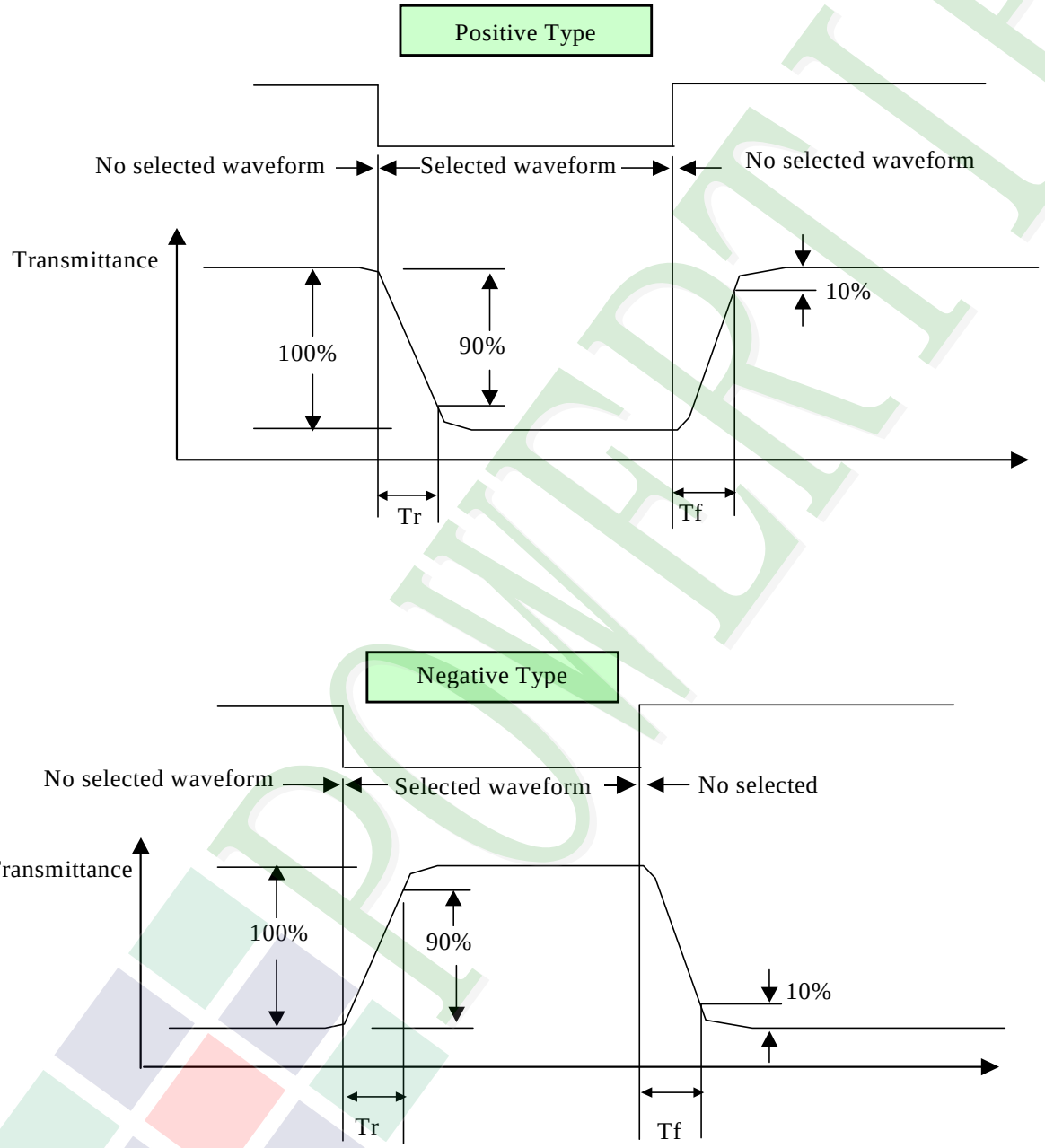


Viewing angle

Note 2.

Optical characteristics-3

Fig.2 Definition of response time



Electrical characteristics-2

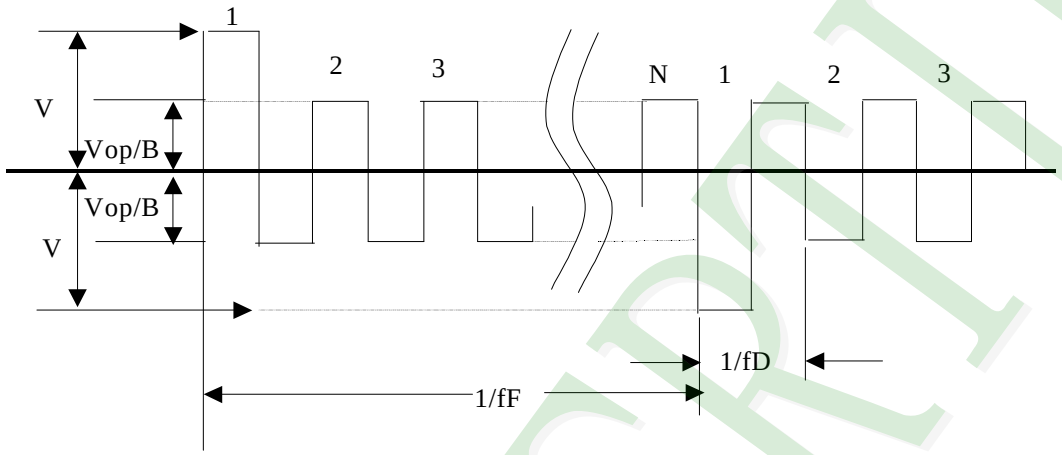
※2 Drive waveform

Vop: Drive voltage　　fF: Frame frequency

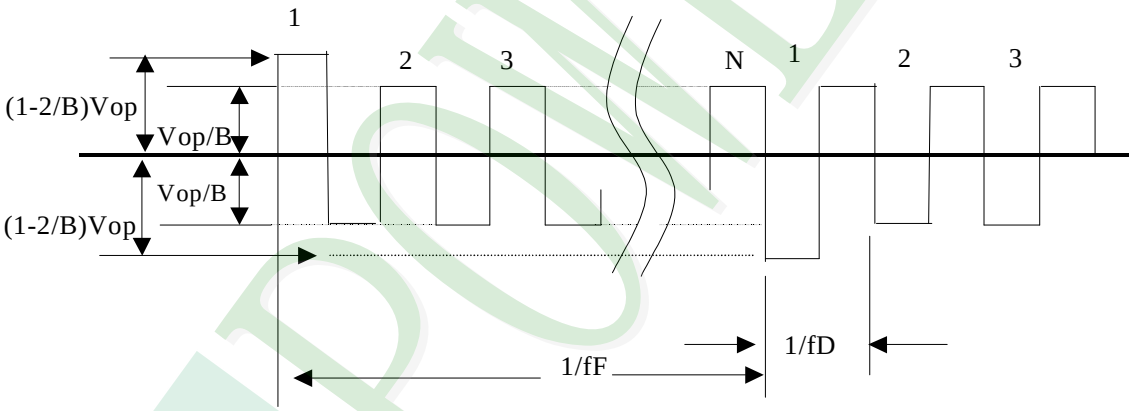
1/B: Bias　　fD: Drive frequency

N: Duty

(1) Selected waveform



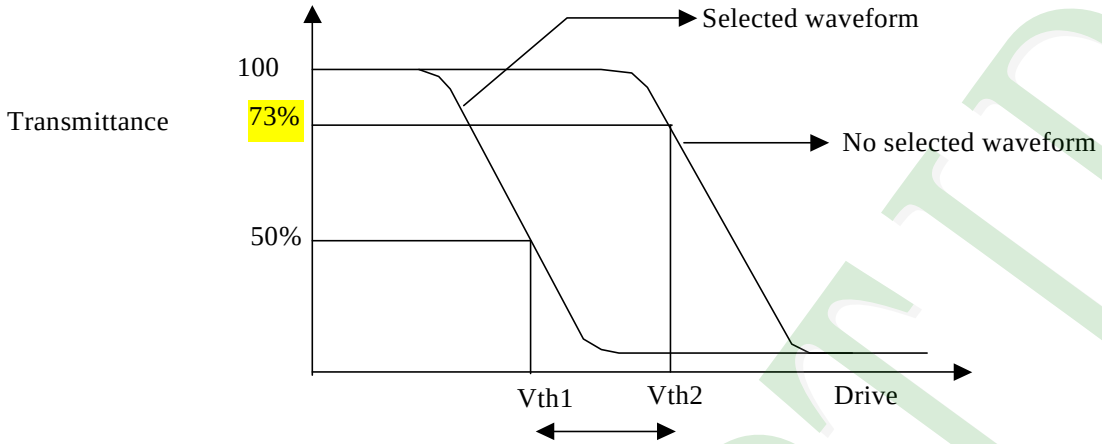
(2) Non- Selected wave form



Note:

Frame frequency is defined as follows: Common side supply voltage peak - to - peak /2 = 1 period

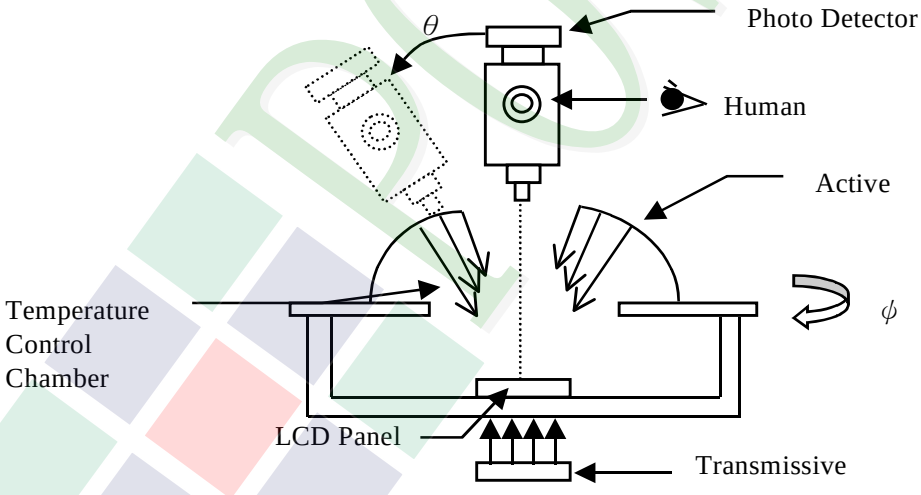
Note 3. : Definition of Vth



	Vth1	Vth2
View direction	10°	40°
Drive waveform	(Selected waveform)	(No selected waveform)
Transmittance	50%	73%

※1 Contrast ratio
= (Brightness in OFF state) / (Brightness in ON state)

Outline of Electro-Optical Characteristics Measuring System



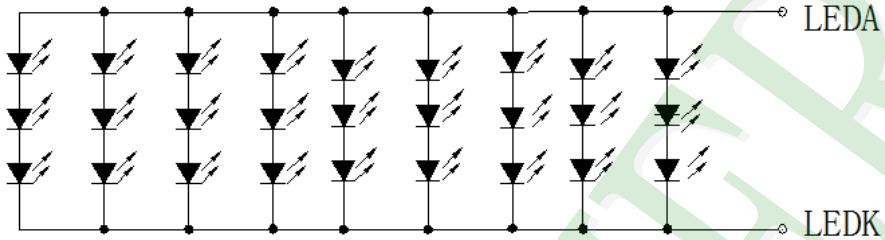
Measuring System: Autronic DMS-803

1.6 Backlight Characteristics

Electrical / Optical Characteristics

Item	Symbol	Conditions	Min.	Typ.	Max.	Unit
Forward Voltage	VF	If=270mA	8.7	9.6	10.5	V
Supply Current	IF	-	-	270	-	mA
Color	White					

Circuit diagram



VF=9.6V(Typ), IF=270mA(Fix)

Other Description

Item	Conditions	Description
Life Time	Ta =25℃ IF= 270mA	50000 hrs

1.7 Touch Panel Characteristics

Features

Item	Standard Value
Touch Panel Size	7”
Power Supply Voltage	3.3V
Input Method	Finger Or Conductive Pen
Output Interface	I^2C
IC	FT5426

Mechanical Specifications

Item	Standard Value	Unit
Outside Dimension	192.96 (W) x 110.76 (H)	mm
Viewing Area	154.88 (W) x 86.72 (H)	mm
Active Area	155.88 (W) x 87.72 (H)	mm

Absolute Maximum Ratings

Item	Symbol	Condition	Min.	Max.	Unit
Supply voltage	VDD	-	-0.3	3.6	V
Operating Temperature	T_{OP}	-	-20	+70	°C
Storage Temperature	T_{ST}	-	-30	+80	°C

Optical Characteristics

Item	Standard Value	Unit
Total light transmittance	85% or more	-
Hardness	⩾7H	-

PIN Definition

Pin No.	Symbol	Function
1	GND	Ground.
2	VDD	Power supply.
3	SCL	I2C serial clock.
4	SDA	I2C serial data.
5	INT	Indicate coordinate data ready.
6	RESET	System reset signal input, active low.

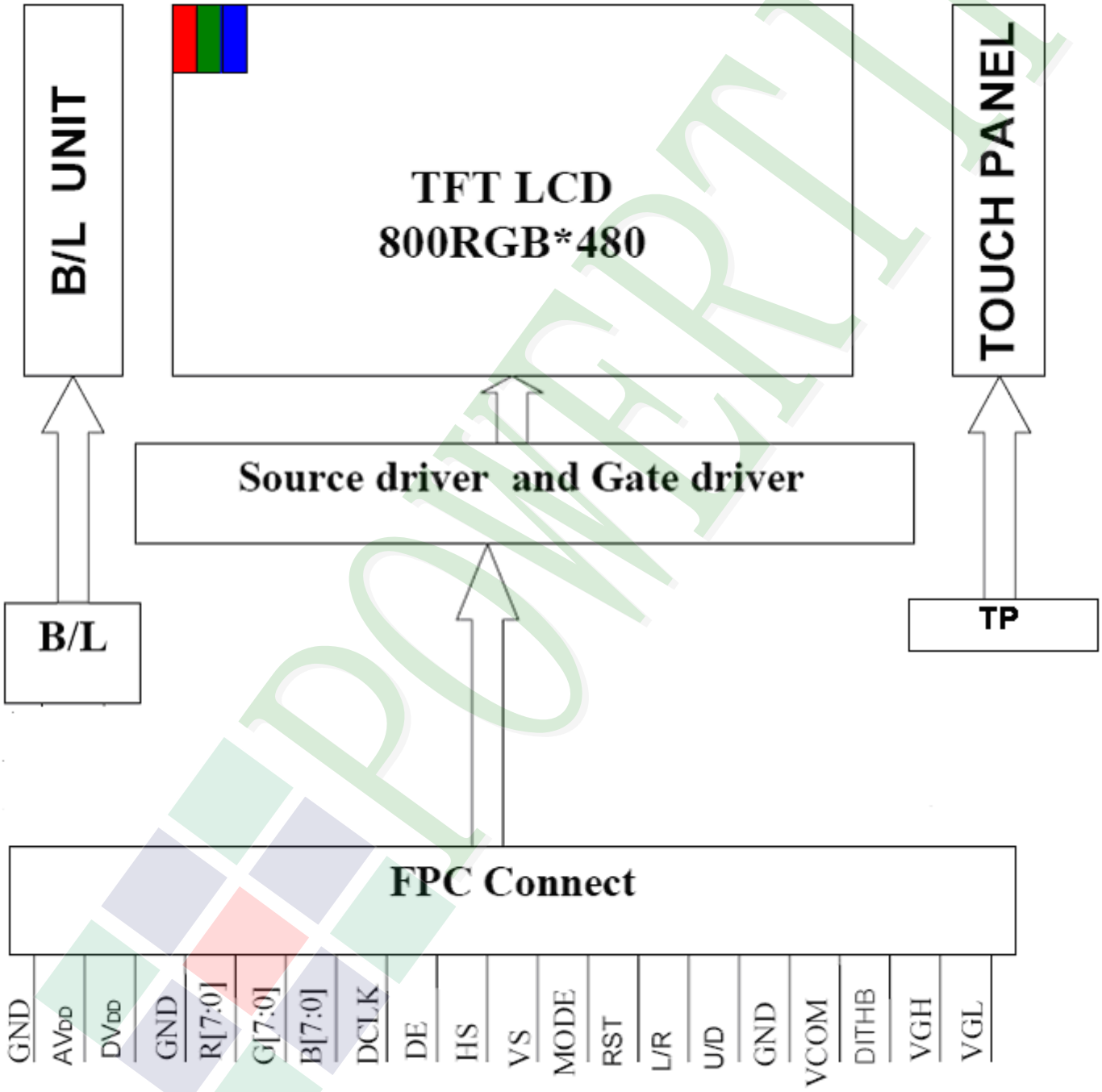
2. MODULE STRUCTURE

2.1 Counter Drawing

2.1.1 LCM Mechanical Diagram

* See Appendix

2.1.2 Block Diagram



2.2 Interface Pin Description

Pin NO.	SYMBOL	DESCRIPTION
1	V_{LED+}	Power For LED backlight (+).
2	V_{LED+}	Power For LED backlight (+).
3	V_{LED-}	Power For LED backlight (-).
4	V_{LED-}	Power For LED backlight (-).
5	GND	Power ground.
6	V_{com}	Common voltage.
7	DV_{DD}	Power for Digital Circuit.
8	MODE	DE/SYNC mode select.
9	DE	Data Input Enable.
10	VS	Vertical Sync Input.
11	HS	Horizontal Sync Input.
12	B7	Blue Data(MSB).
13	B6	Blue Data.
14	B5	Blue Data.
15	B4	Blue Data.
16	B3	Blue Data.
17	B2	Blue Data.
18	B1	Blue Data.
19	B0	Blue Data(LSB).
20	G7	Green Data(MSB).
21	G6	Green Data.
22	G5	Green Data.
23	G4	Green Data.
24	G3	Green Data.
25	G2	Green Data.
26	G1	Green Data.
27	G0	Green Data(LSB).
28	R7	Red Data(MSB).
29	R6	Red Data.
30	R5	Red Data.
31	R4	Red Data.
32	R3	Red Data.
33	R2	Red Data.
34	R1	Red Data.
35	R0	Red Data(LSB).
36	GND	Power Ground
37	DCLK	Sample clock

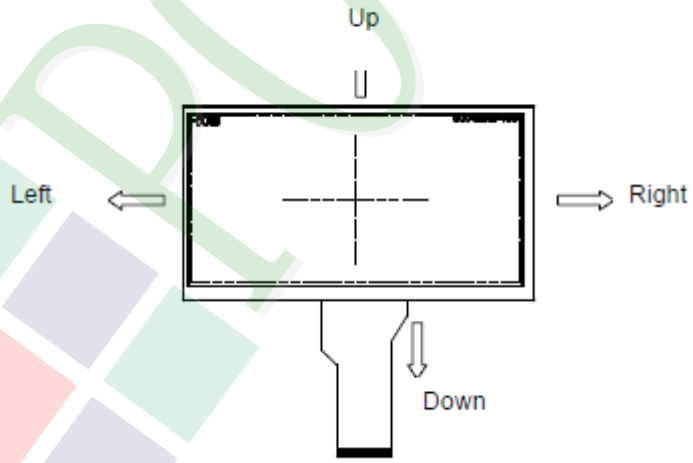
Pin NO.	SYMBOL	DESCRIPTION
38	GND	Power Ground.
39	L/R	Left / right selection.
40	U/D	Left / right selection.
41	V_{GH}	Gate On Voltage.
42	V_{GL}	Gate OFF Voltage.
43	AV_{DD}	Power for Analog Circuit.
44	RESET	Global reset pin.
45	NC	No connection.
46	V_{COM}	Common Voltage.
47	DITHB	Dithering Function.
48	GND	Power Ground.
49	NC	No connection.
50	NC	No connection.

【Note1】L/R：left or right setting

U/D：up or down setting

L/R	U/D	Data shifting
DVDD	GND	Left → Right，Up → Down(default)
GND	GND	Right → Left，Up → Down
DVDD	DVDD	Left → Right，Down → Up
GND	DVDD	Right → Left，Down → Up

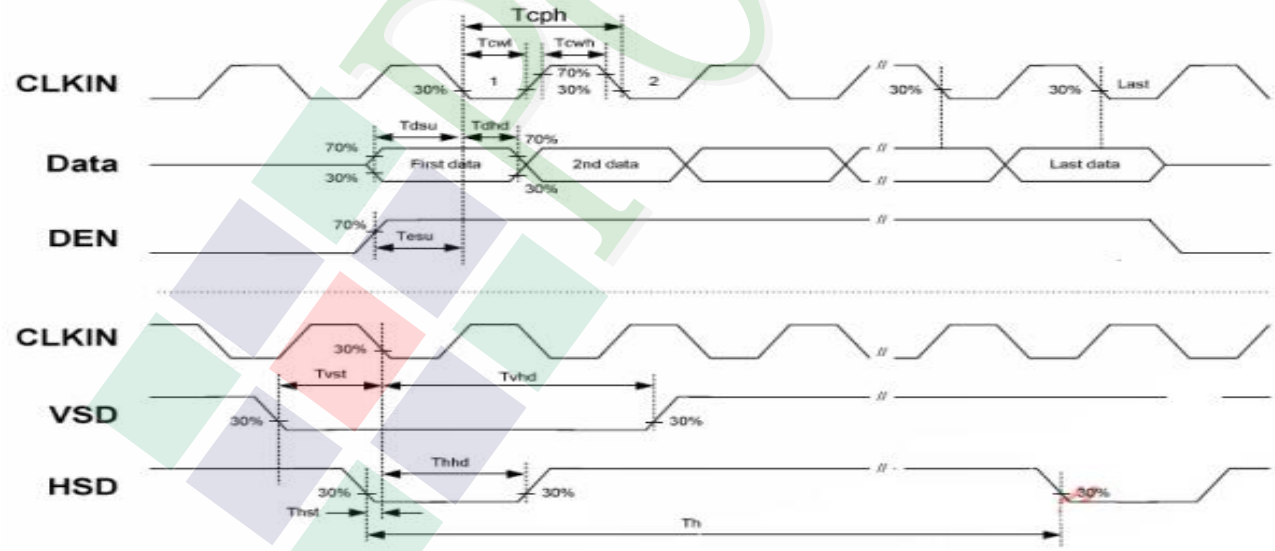
Definition of scanning direction:



2.3 Timing Characteristics

2.3.1 AC Electrical Characteristics

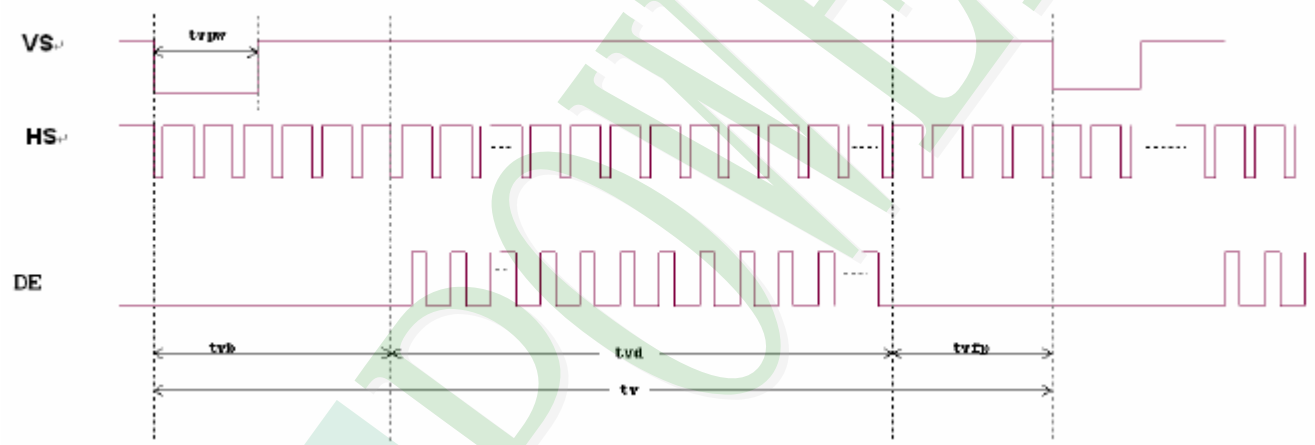
Item	Symbol	Values			Unit	Remark
		Min.	Typ.	Max.		
HS setup time	T_{hst}	8	-	-	ns	
HS hold time	T_{hhd}	8	-	-	ns	
VS setup time	T_{vst}	8	-	-	ns	
VS hold time	T_{vhd}	8	-	-	ns	
Data setup time	T_{dsu}	8	-	-	ns	
Data hole time	T_{dhd}	8	-	-	ns	
DE setup time	T_{esu}	8	-	-	ns	
DE hole time	T_{ehd}	8	-	-	ns	
DV_{DD} Power On Slew rate	T_{POR}	-	-	20	ms	From 0 to 90% DV_{DD}
RESET pulse width	T_{Rst}	1	-	-	ms	
DCLK cycle time	T_{coh}	20	-	-	ns	
DCLK pulse duty	T_{cwh}	40	50	60	%	



2.3.2 Data Input Format

Horizontal input timing diaqram

Vertial input timing diaqram

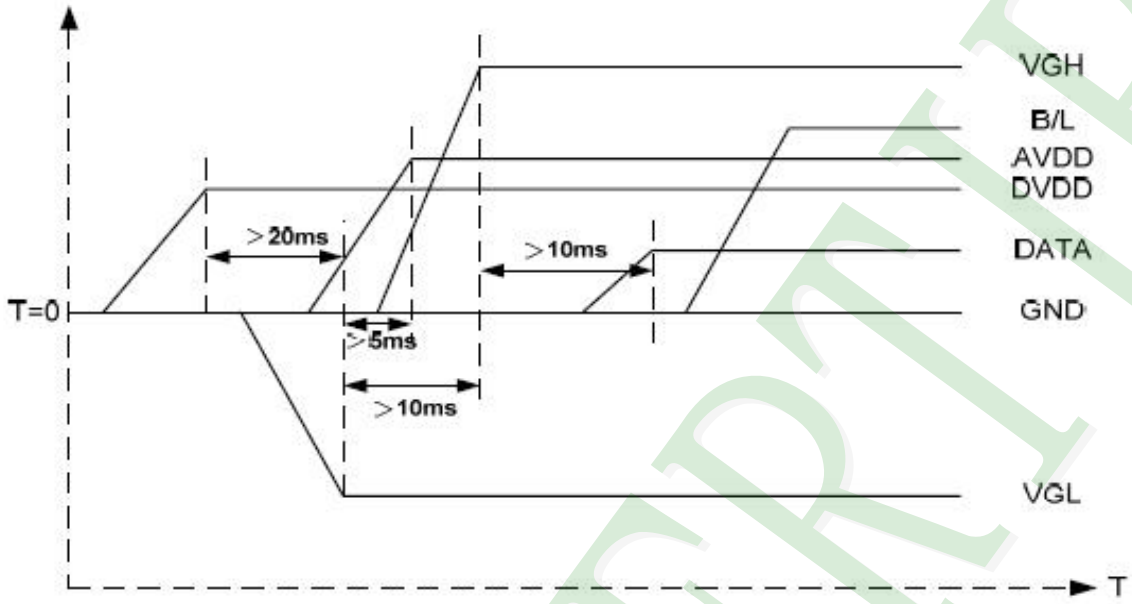


Item	Symbol	Values			Unit	Remark
		Min.	Typ.	Max.		
Horizontal Display Area	thd	-	800	-	DCLK	
DCLK Frequency	fclk	26.4	33.3	46.8	MHz	
One Horizontal Line	th	862	1056	1200	DCLK	
HS pulse width	thpw	1	-	40	DCLK	
HS Blanking	thb	46	46	46	DCLK	
HS Front Porch	thfp	16	210	354	DCLK	

Item	Symbol	Values			Unit	Remark
		Min.	Typ.	Max.		
Vertical Display Area	tvd	-	480	-	TH	
VS period time	tv	510	525	650	TH	
VS pulse width	tvpw	1	-	20	TH	
VS Blanking	tvb	23	23	23	TH	
VS Front Porch	tvfp	7	22	147	TH	

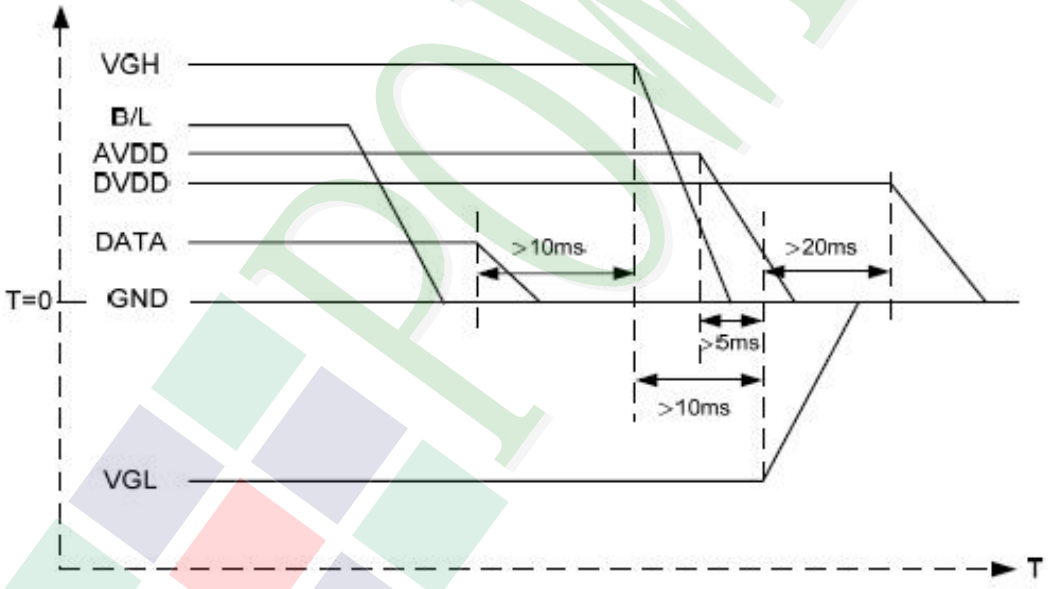
2.3.3 Power On/Off Characteristics

a. Power on:



DV_{DD}→VGL→VGH→Data→B/L

b. Power off:

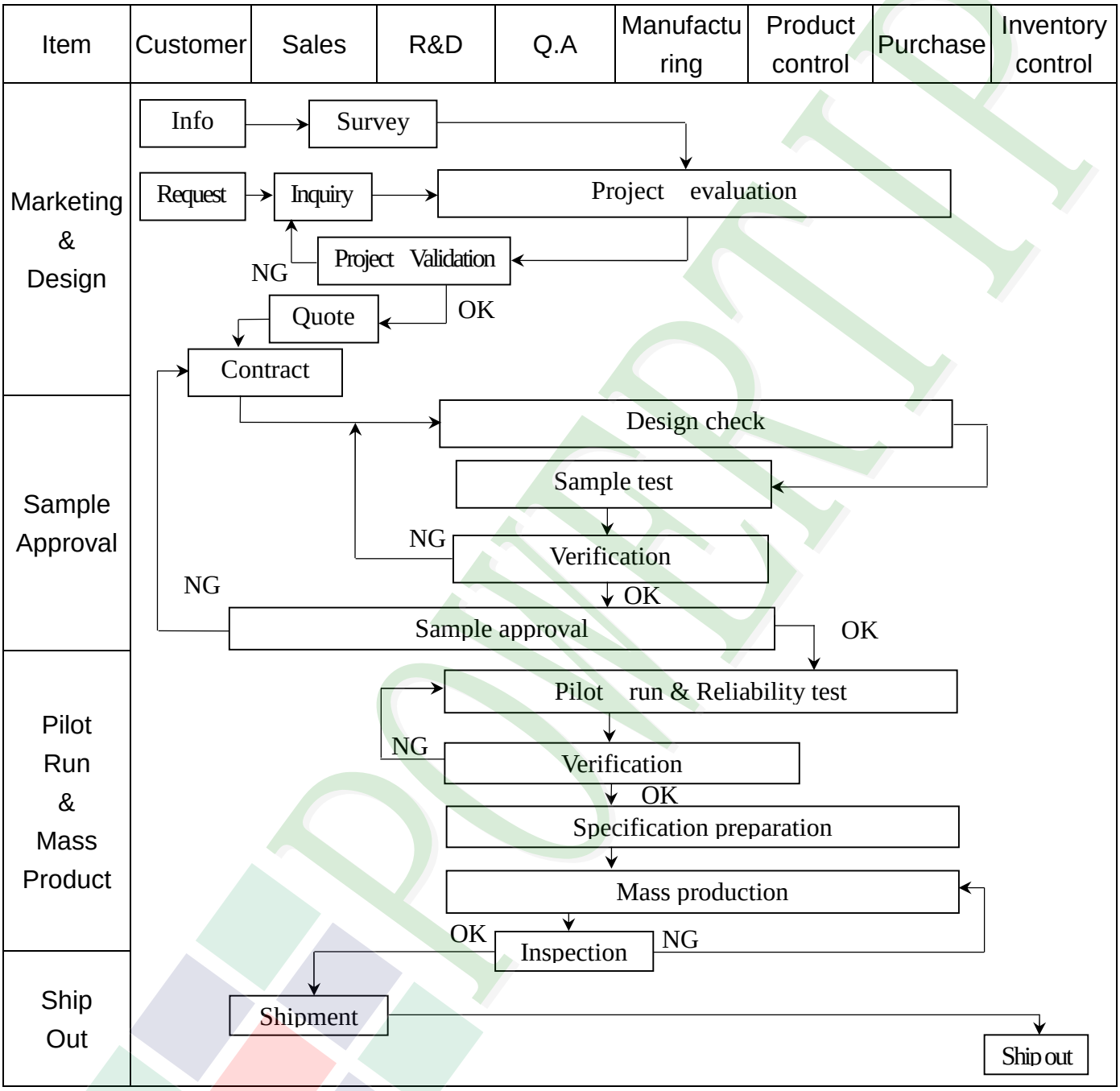


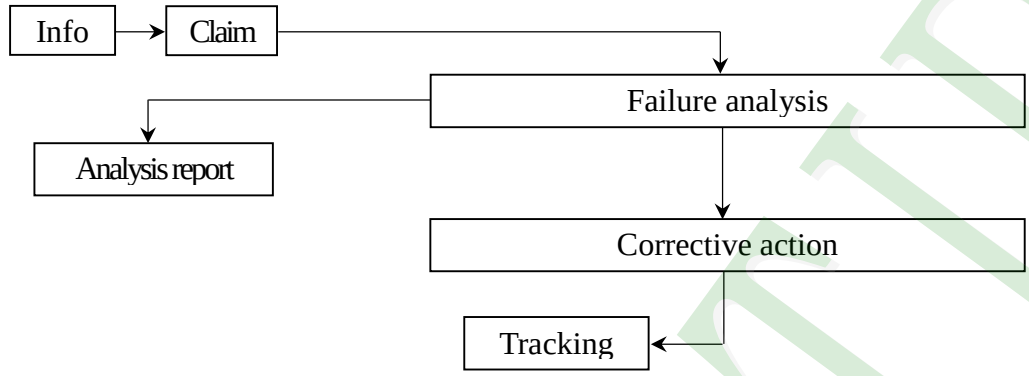
B/L→Data→VGH→VGL→DV_{DD}

Note: Data include R0~R7, B0~B7, GO~G7, U/D, L/R, DCLK, HS,VS,DE.

3. QUALITY ASSURANCE SYSTEM

3.1 Quality Assurance Flow Chart



Item	Customer	Sales	R&D	Q.A	Manufacturing	Product control	Purchase	Inventory control
Sales Service								
Q.A Activity	1. ISO 9001 Maintenance Activities 2. Process improvement proposal 3. Equipment calibration 4. Education And Training Activities 5. Standardization Management							

3.2 Inspection Specification

◆**Scope：The document shall be applied to TFT-LCD Module for 3.5″ ~15″ (Ver.B01).**

◆**Inspection Standard：MIL-STD-105E Table Normal Inspection Single Sampling Level Ⅱ.**

◆**Equipment：Gauge、MIL-STD、Powertip Tester、Sample**

◆**Defect Level：Major Defect AQL： 0.4 ； Minor Defect AQL： 1.5**

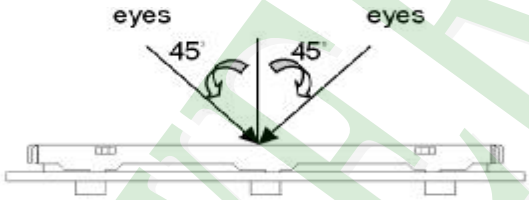
◆**OUT Going Defect Level：Sampling.**

◆**Standard of the product appearance test：**

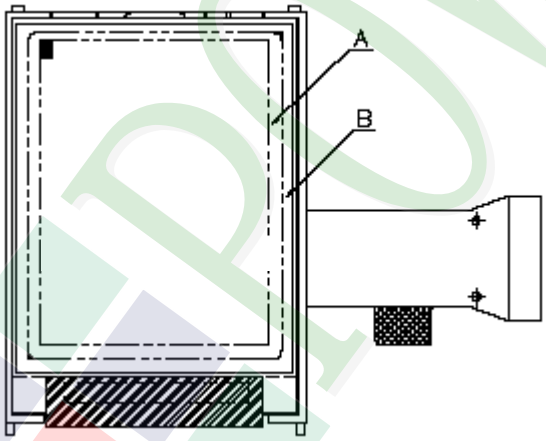
a. Manner of appearance test：

(1). The test best be under 20W×2 fluorescent light，and distance of view must be at 30 cm.

(2). The test direction is base on about around 45° of vertical line.



(3). Definition of area.



A **area : viewing area**

B **area : Outside of viewing area**

(4). Standard of inspection： (Unit：mm)

◆Specification For TFT-LCD Module 3.5″ ~15″： (Ver.B01)

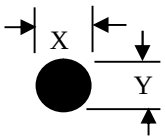
<table>
<tr><th>NO</th><th>Item</th><th>Criterion</th><th>Level</th></tr>
<tr><td rowspan="3">01</td><td rowspan="3">Product condition</td><td>1.1The part number is inconsistent with work order of production.</td><td>Major</td></tr>
<tr><td>1.2 Mixed product types.</td><td>Major</td></tr>
<tr><td>1.3 Assembled in inverse direction.</td><td>Major</td></tr>
<tr><td>02</td><td>Quantity</td><td>2.1The quantity is inconsistent with work order of production.</td><td>Major</td></tr>
<tr><td>03</td><td>Outline dimension</td><td>3.1 Product dimension and structure must conform to structure diagram.</td><td>Major</td></tr>
<tr><td rowspan="6">04</td><td rowspan="6">Electrical Testing</td><td>4.1 Missing line character and icon.</td><td>Major</td></tr>
<tr><td>4.2 No function or no display.</td><td>Major</td></tr>
<tr><td>4.3 Display malfunction.</td><td>Major</td></tr>
<tr><td>4.4 LCD viewing angle defect.</td><td>Major</td></tr>
<tr><td>4.5 Current consumption exceeds product specifications.</td><td>Major</td></tr>
<tr><td>4.6 Mura can not be seen through 5% ND filter.
(Mura : Under the normal examination angle of view,the picture has the non-uniform phenomenon.)</td><td>Minor</td></tr>
<tr><td>05</td><td>Dot defect

(Bright dot、Dark dot)

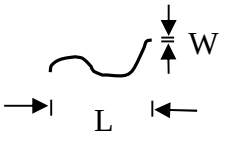
On -display</td><td>
<table>
<tr><th colspan="2">Item</th><th>Acceptance (Q’ty)</th></tr>
<tr><td rowspan="4">Dot Defect</td><td>Bright Dot</td><td>≦ 4</td></tr>
<tr><td>Dark Dot</td><td>≦ 5</td></tr>
<tr><td>Joint Dot</td><td>≦ 3</td></tr>
<tr><td>Total</td><td>≦ 7</td></tr>
</table>
5.1 Inspection pattern：full white , full black , Red , Green and blue screens.
5.2 It is defined as dot defect if defect area ＞1/2 dot.
5.3 The distance between two dot defect ≧5 mm.
5.4 Bright dot that can not be seen through 5% ND filter.
</td><td>Minor</td></tr>
</table>

◆Specification For TFT-LCD Module 3.5″ ~15″： (Ver.B01)

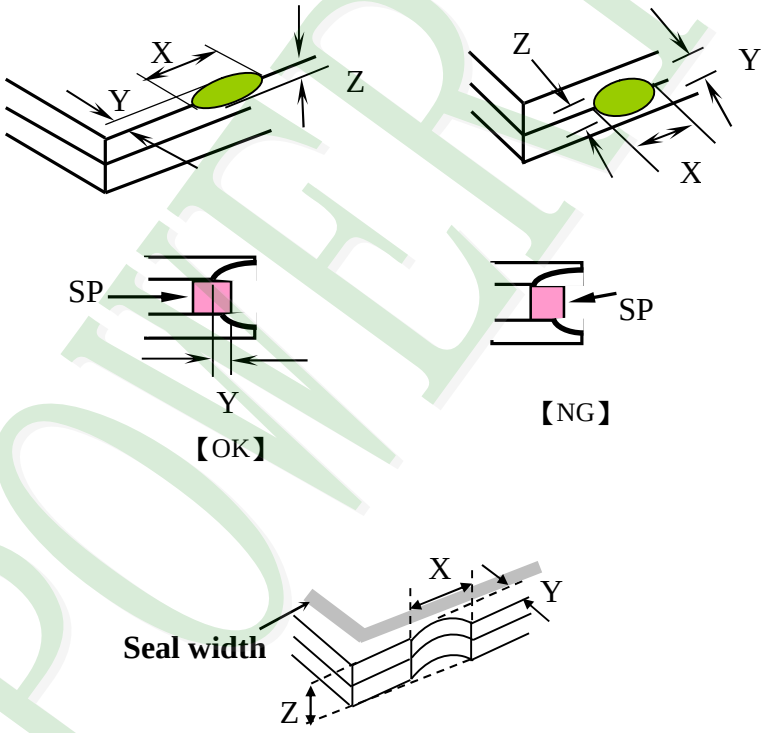
<table>
<tr><th>NO</th><th>Item</th><th>Criterion</th><th>Level</th></tr>
<tr><td>06</td><td>Black or white dot、scratch、contamination

Round type
 

Φ＝(x＋y) / 2

Line type
 
</td><td>6.1 Round type (Non-display or display)：
<table>
<tr><th rowspan="2">Dimension (diameter：Φ)</th><th colspan="2">Acceptance (Q’ty)</th></tr>
<tr><th>A area</th><th>B area</th></tr>
<tr><td>Φ ≦ 0.25</td><td>Ignore</td><td rowspan="4">Ignore</td></tr>
<tr><td>0.25 ＜ Φ ≦ 0.50</td><td>5</td></tr>
<tr><td>Φ ＞ 0.50</td><td>0</td></tr>
<tr><td>Total</td><td>5</td></tr>
</table>
6.2 Line type(Non-display or display)：
<table>
<tr><th rowspan="2">module size</th><th rowspan="2">Length (L)</th><th rowspan="2">Width (W)</th><th colspan="2">Acceptance (Q’ty)</th></tr>
<tr><th>A area</th><th>B area</th></tr>
<tr><td rowspan="5">3.5” to less 9”</td><td>---</td><td>W ≦ 0.03</td><td>Ignore</td><td rowspan="5">Ignore</td></tr>
<tr><td>L ≦10.0</td><td>0.03 ＜W ≦ 0.05</td><td>4</td></tr>
<tr><td>L ≦5.0</td><td>0.05 ＜W ≦ 0.10</td><td>2</td></tr>
<tr><td>---</td><td>W ＞0.10</td><td>As round type</td></tr>
<tr><td colspan="2">Total</td><td>5</td></tr>
<tr><td rowspan="4">9” to 15”</td><td>---</td><td>W ≦ 0.05</td><td>Ignore</td><td rowspan="4">Ignore</td></tr>
<tr><td>L ≦10.0</td><td>0.05 ＜W ≦ 0.10</td><td>5</td></tr>
<tr><td>---</td><td>W ＞0.10</td><td>As round type</td></tr>
<tr><td colspan="2">Total</td><td>5</td></tr>
</table></td><td>Minor</td></tr>
<tr><td>07</td><td>Polarizer Bubble</td><td>
<table>
<tr><th rowspan="2">Dimension (diameter：Φ)</th><th colspan="2">Acceptance (Q’ty)</th></tr>
<tr><th>A area</th><th>B area</th></tr>
<tr><td>Φ ≦ 0.25</td><td>Ignore</td><td rowspan="5">Ignore</td></tr>
<tr><td>0.25 ＜ Φ ≦ 0.50</td><td>4</td></tr>
<tr><td>0.50 ＜ Φ ≦ 0.80</td><td>1</td></tr>
<tr><td>Φ ＞ 0.80</td><td>0</td></tr>
<tr><td>Total</td><td>5</td></tr>
</table></td><td>Minor</td></tr>
</table>

◆Specification For TFT-LCD Module 3.5″ ~15″： (Ver.B01)

NO	Item	Criterion	Level
08	The crack of glass	**Symbols：** **X : The length of crack** **Y : The width of crack.** **Z : The thickness of crack** **W : terminal length** **t : The thickness of glass** **a : LCD side length** 8.1 General glass chip： 8.1.1 **Chip on panel surface and crack between panels:**  	Minor

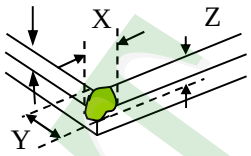
X	Y	Z
≦ a	**Crack can't enter viewing area**	≦1/2 t
≦ a	**Crack can't exceed the half of SP width.**	1/2 t ＜ Z ≦2 t

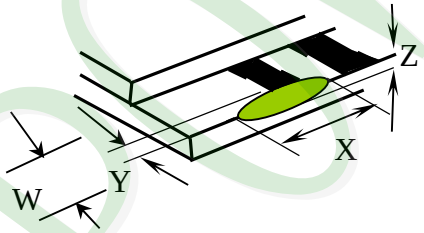
◆Specification For TFT-LCD Module 3.5″ ~15″：

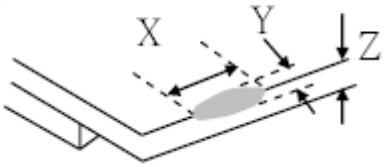
(Ver.B01)

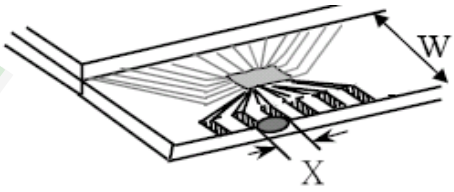
<table>
<tr><th>NO</th><th>Item</th><th>Criterion</th><th>Level</th></tr>
<tr><td rowspan="2">08</td><td rowspan="2">The crack of glass</td><td>
Symbols：

X : The length of crack Y : The width of crack.
Z : The thickness of crack W : terminal length
t : The thickness of glass a : LCD side length

8.1.2 Corner crack：


<table>
<tr><th>X</th><th>Y</th><th>Z</th></tr>
<tr><td>≦1/5 a</td><td>Crack can’t enter viewing area</td><td>Z ≦ 1/2 t</td></tr>
<tr><td>≦1/5 a</td><td>Crack can’t exceed the half of SP width.</td><td>1/2 t ＜ Z ≦ 2 t</td></tr>
</table>
</td><td rowspan="2">Minor</td></tr>
<tr><td>
8.2 Protrusion over terminal：
8.2.1 Chip on electrode pad：




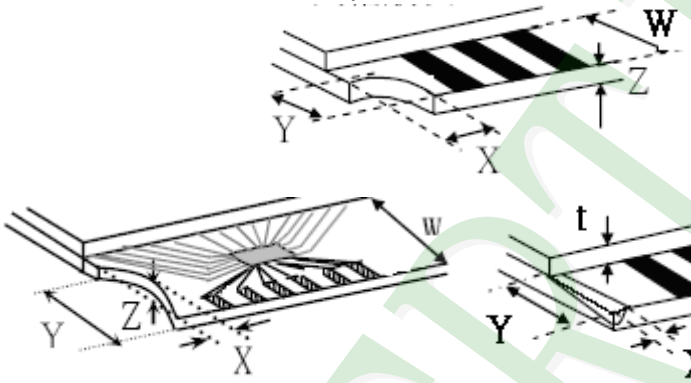


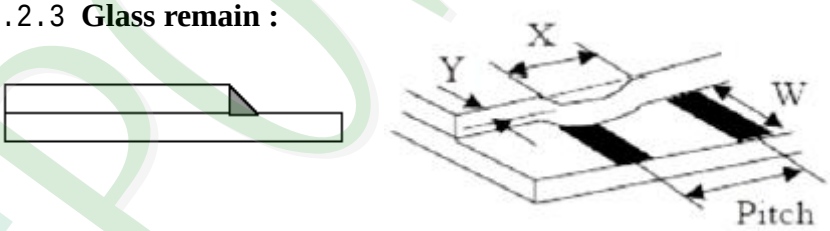
<table>
<tr><th></th><th>X</th><th>Y</th><th>Z</th></tr>
<tr><td>Front</td><td>≦ a</td><td>≦ 1/2 W</td><td>≦ t</td></tr>
<tr><td>Back</td><td>≦ a</td><td>≦ W</td><td>≦ 1/2 t</td></tr>
</table>
</td></tr>
</table>

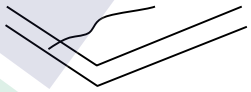
◆Specification For TFT-LCD Module 3.5″ ~15″： (Ver.B01)

<table>
<tr><th>NO</th><th>Item</th><th>Criterion</th><th>Level</th></tr>
<tr><td>08</td><td>The crack of glass</td><td>
Symbols：

X : The length of crack　　Y : The width of crack.
Z : The thickness of crack　　W : terminal length
t : The thickness of glass　　a : LCD side length

8.2.2 Non-conductive portion：


<table>
<tr><th>X</th><th>Y</th><th>Z</th></tr>
<tr><td>≦ 1/3 a</td><td>≦ W</td><td>≦t</td></tr>
</table>
⊙ If the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications.
8.2.3 Glass remain :


<table>
<tr><th>X</th><th>Y</th><th>Z</th></tr>
<tr><td>≦ a</td><td>≦ 1/3 W</td><td>≦t</td></tr>
</table>
8.2.4 Cracking

Not Allowed
</td><td>Minor</td></tr>
</table>

◆Specification For TFT-LCD Module 3.5″ ~15″： (Ver.B01)

NO	Item	Criterion	Level
09	Backlight elements	9.1 Backlight can't work normally.	Major
		9.2 Backlight doesn't light or color is wrong.	Major
		9.3 Illumination source flickers when lit.	Major
10	General appearance	10.1 Pin type、quantity、dimension must match type in structure diagram.	Major
		10.2 No short circuits in components on PCB or FPC .	Major
		10.3 Parts on PCB or FPC must be the same as on the production characteristic chart .There should be no wrong parts , missing parts or excess parts.	Major
		10.4 Product packaging must the same as specified on packaging specification sheet.	Minor
		10.5 The folding and peeled off in polarizer are not acceptable.	Minor
		10.6 The PCB or FPC between B/L assembled distance(PCB or FPC) is ≦1.5 mm.	Minor

4. RELIABILITY TEST

4.1 Reliability Test Condition

(Ver.B01)

NO.	TEST ITEM	TEST CONDITION
1	High Temperature Storage Test	Keep in +80 ±2℃ 96 hrs Surrounding temperature, then storage at normal condition 4hrs.
2	Low Temperature Storage Test	Keep in -30 ±2℃ 96 hrs Surrounding temperature, then storage at normal condition 4hrs.
3	High Temperature / High Humidity Storage Test	Keep in +60℃ / 90% R.H duration for 96 hrs Surrounding temperature, then storage at normal condition 4hrs. (Excluding the polarizer)
4	Temperature Cycling Storage Test	-30℃ → +25℃ → +80℃ → +25℃ (30mins) (5mins) (30mins) (5mins) 10 Cycle Surrounding temperature, then storage at normal condition 4hrs.
5	ESD Test	Air Discharge: Apply 2 KV with 5 times Discharge for each polarity +/- Contact Discharge: Apply 250 V with 5 times discharge for each polarity +/- 1. Temperature ambiance : 15℃～35℃ 2. Humidity relative : 30%～60% 3. Energy Storage Capacitance(Cs+Cd) : 150pF±10% 4. Discharge Resistance(Rd) : 330Ω±10% 5. Discharge, mode of operation : Single Discharge (time between successive discharges at least 1 sec) (Tolerance if the output voltage indication : ±5%)
6	Vibration Test (Packaged)	1. Sine wave 10～55 Hz frequency (1 min) 2. The amplitude of vibration :1.5 mm 3. Each direction (X、Y、Z) duration for 2 Hrs
7	Drop Test (Packaged)	Packing Weight (Kg) / Drop Height (cm): 0 ~ 45.4 — 122 45.4 ~ 90.8 — 76 90.8 ~ 454 — 61 Over 454 — 46 Drop direction :※1 corner / 3 edges / 6 sides each 1times

5. PRECAUTION RELATING PRODUCT HANDLING

5.1 SAFETY

5.1.1 If the LCD panel breaks , be careful not to get the liquid crystal to touch your skin.

5.1.2 If the liquid crystal touches your skin or clothes , please wash it off immediately by using soap and water.

5.2 HANDLING

5.2.1 Avoid any strong mechanical shock which can break the glass.

5.2.2 Avoid static electricity which can damage the CMOS LSI—When working with the module , be sure to ground your body and any electrical equipment you may be using.

5.2.3 Do not remove the panel or frame from the module.

5.2.4 The polarizing plate of the display is very fragile. So , please handle it very carefully ,do not touch , push or rub the exposed polarizing with anything harder than an HB pencil lead (glass , tweezers , etc.)

5.2.5 Do not wipe the polarizing plate with a dry cloth , as it may easily scratch the surface of plate.

5.2.6 Do not touch the display area with bare hands , this will stain the display area.

5.2.7 Do not use ketonics solvent & aromatic solvent. Use with a soft cloth soaked with a cleaning naphtha solvent.

5.2.8 To control temperature and time of soldering is 320±10℃and 3-5 sec.

5.2.9 To avoid liquid (include organic solvent) stained on LCM .

5.3 STORAGE

5.3.1 Store the panel or module in a dark place where the temperature is 25℃ ±5℃ and the humidity is below 65% RH.

5.3.2 Do not place the module near organics solvents or corrosive gases.

5.3.3 Do not crush , shake , or jolt the module.

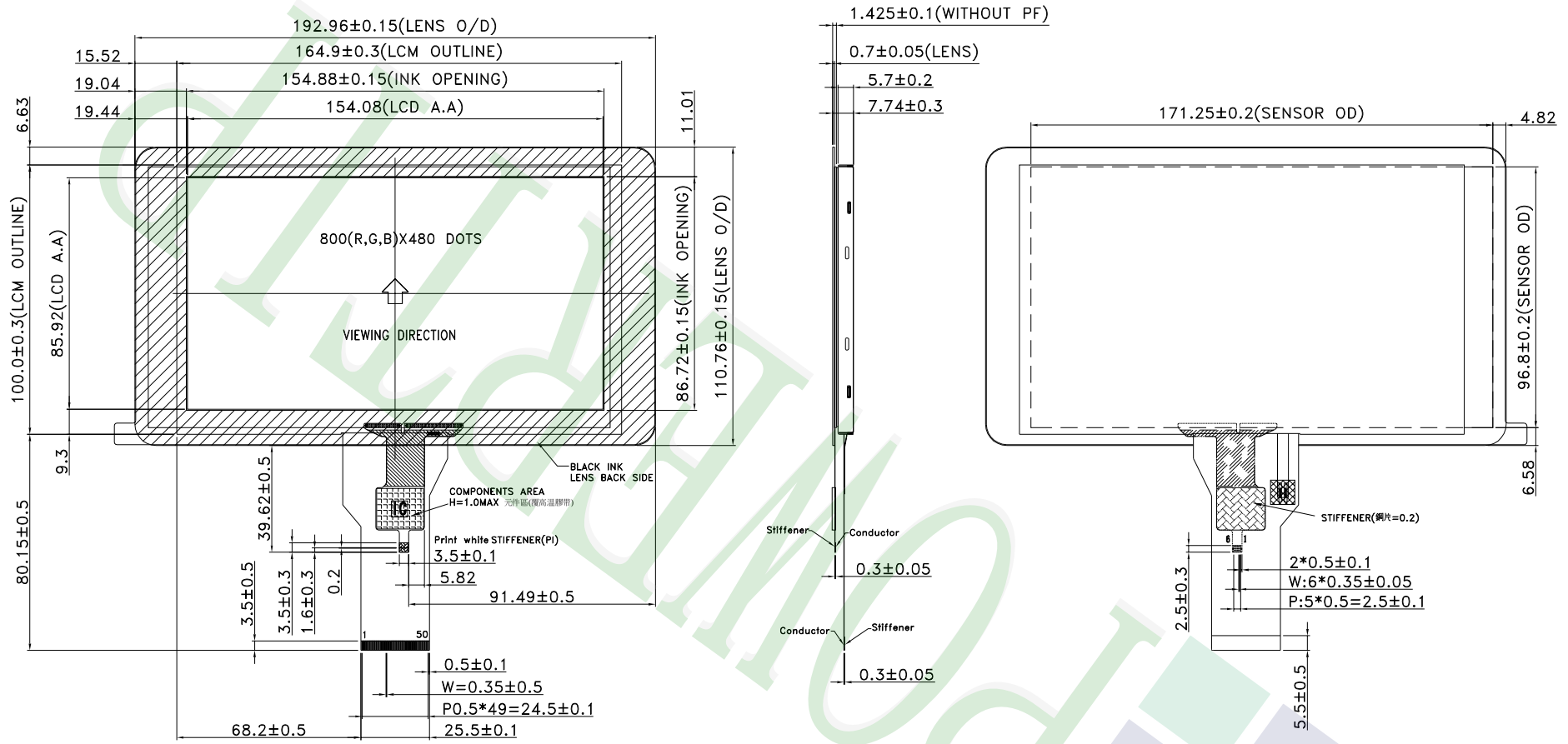
5.4 TERMS OF WARRANTY

5.4.1 Applicable warrant period

The period is within thirteen months since the date of shipping out under normal using and storage conditions.

5.4.2 Unaccepted responsibility

This product has been manufactured to your company's specification as a part for use in your company's general electronic products. It is guaranteed to perform according to delivery specifications. For any other use apart from general electronic equipment , we cannot take responsibility if the product is used in nuclear power control equipment , aerospace equipment , fire and security systems or any other applications in which there is a direct risk to human life and where extremely high levels of reliability are required.



NOTES:

1. LCD TYPE: TFT LCD
2. LCD DISPLAY: POSITIVE/TRANSMISSIVE
3. VIEW DIRECTION: 80/80/80/80
4. The tolerance unless classified ±0.3mm
5. FPC suggested connector :
   LCM:HIROSE FH12A-50S-0.5H or compatible
   CTP:HIROSE FH34S-6S-0.5SH or compatible

REV	REV BY	REVISER	DATE
007			
006			
005			
004			
003			
002			
001	NEW DRAWING	Terry	2016/10/17

PART NO: PH800480T013-IDF02

DRAWING NAME : JLMD-PH800480T013-IDF02

TITLE: LCD MODULE DRAWING

久正光電股份有限公司
POWERTIP TECHNOLOGY CORPORATION

Design	Terry	(3) Surface	
Check	Eddy	Unit MM	Material
Scale	FIT		Thickness
Approve	Ryan	Page 1/1	Quantity

Precision / Tolerance Length(Min) (mm)	Precision Level
1 ~ 4	-
4 ~ 16	-
16 ~ 63	-
63 ~ 250	-
250 ~ 1000	-

PT-A-054-0

Ver.001

Documents NO.	JPKG-PH800480T013-IDF01

LCM包裝規格書
LCM Packaging Specifications (For Tray)

Approve	Check	Contact
Ryan	Eddy	Terry

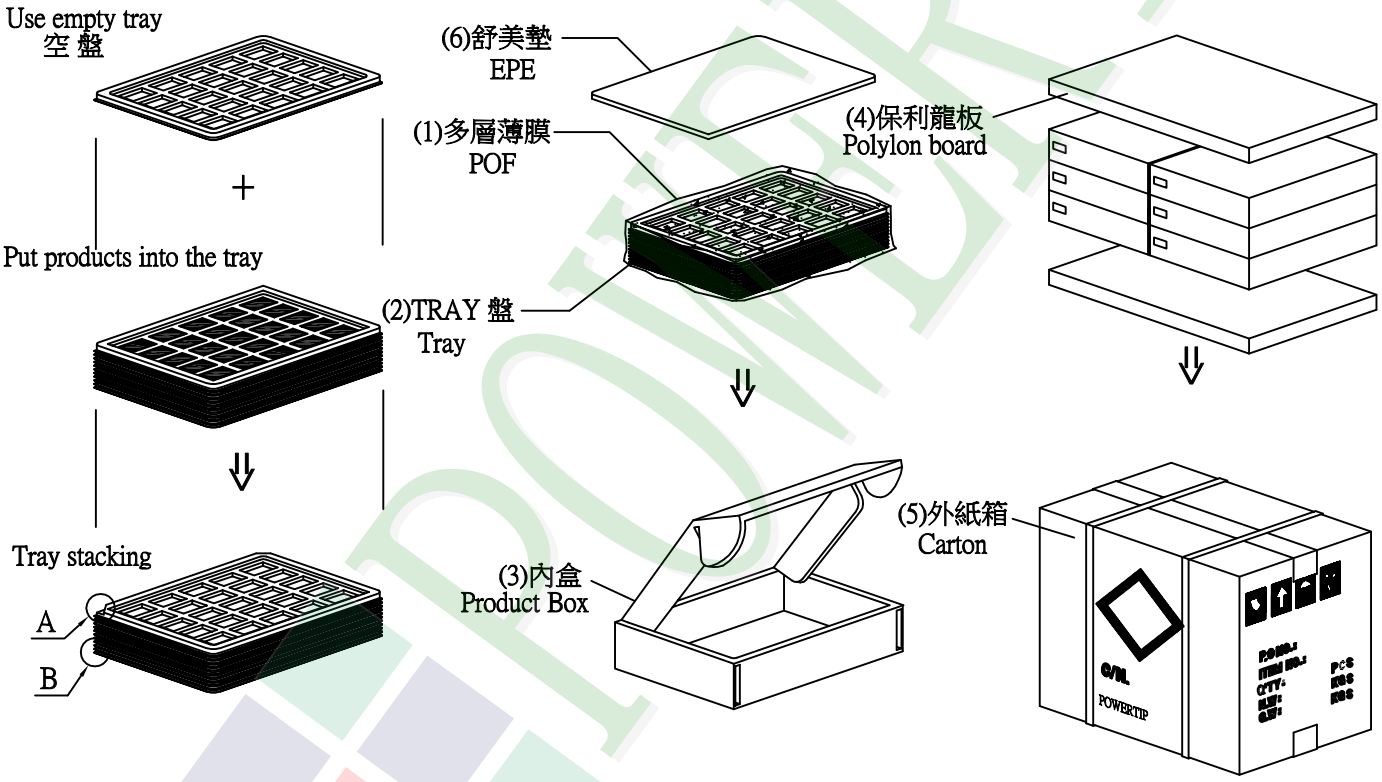
1.包裝材料規格表 (Packaging Material) : (per carton)

No.	Item	Model	Dimensions (mm)	1Pcs Weight	Quantity	Total Weight
1	成品 (LCM)	PH800480T013-IDF01	192.96 X 108.76X7.63	0.2148	48	10.3104
2	多層薄膜(1)POF	OTFILM0BA03ABA	19"X350X0.015	——	6	——
3	TRAY 盤 (2)Tray	TY00000000399	352 X 260 X 16.5	0.1	30	3.0
4	內盒(3)Product Box	BX36627063ABBA	393 X 274 X 68	0.182	6	1.092
5	保利龍板(4)Polylon board	OTPLB00PL08ABA	550 X 393 X 20	0.0284	2	0.0568
6	外紙箱(5)Carton	BX57041027CCBA	570 X 410 X 265	1.0	1	1.0
7	舒美墊(6)EPE	FOAM000000047	350 X 255 X 5	0.011	6	0.066
8						
9						

2.一 整箱總重量 (Total LCD Weight in carton) : 15.53 Kg±10%

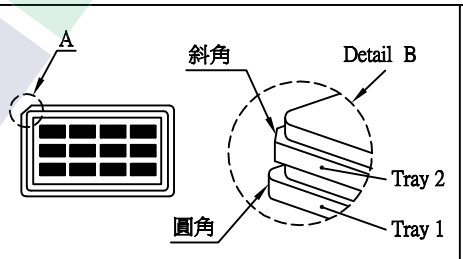
3.單箱數量規格表 (Packaging Specifications and Quantity) :

(1)LCM quantity per box : no per tray	2	x no of tray	4	=	8
(2)Total LCM quantity in carton : quantity per box	8	x no of boxes	6	=	48



特 記 事 項 (REMARK)

1. Label Specifications :
依廠內標準作業



2.TRAY盤相疊時,需旋轉180度,請詳見B視圖
Rotate tray 180 degrees and place on top of stack.
Check the tray stack using Fig. B.